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END920030021US1

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Applicant(s): Campisano et al.

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GROUP

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
/DZ/	US 2001/0006576 A1	07/2001	Kagawa et al.			
/DZ/	US 2002/0034374 A1	03/2002	Barton			
/DZ/	US 2002/0051621 A1	05/2002	Cuccia			
/DZ/	US 2002/0061183 A1	05/2002	MacInnis			
/DZ/	US 2002/0136530 A1	09/2002	Pietraszak			
/DZ/	5,453,790	09/1995	Vermeulen et al.			
/DZ/	5,588,029	12/1996	Maturi et al.			
/DZ/	5,729,648	03/1998	Boyce et al.			
/DZ/	5,960,006	09/1999	Maturi et al.			
/DZ/	6,014,706	01/2000	Cannon et al.			
/DZ/	6,118,921	09/2000	Kim			

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
/DZ/	JP5344494A	12/1993	Japan				

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

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/DZ/	6,141,486	10/2000	Lane et al.			
/DZ/	6,154,603	11/2000	Willis et al.			
/DZ/	US 6,233,389 B1	05/2001	Barton et al.			
/DZ/	US 6,473,558 B1	10/2002	Wu et al.			

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						YES	NO

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